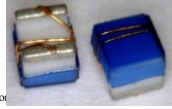


- Higher Q and lower DCR than other 0805 inductors
- Very high SRF values – as high as 6.x GHz
- Excellent current handling capability – up to 800 mA
- 56 inductance values from 2.0 to 2400 nH



Core material Ceramic

Environmental RoHS compliant, halogen free

Terminations Silver-palladium-platinum-glass frit. Other terminations available at additional cost.

Ambient temperature -40°C to +125°C with Irms current

Maximum part temperature +140°C (ambient + temp rise).

Storage temperature Component: -40°C to +140°C.

Tape and reel packaging: -40°C to +140°C.

Resistance to soldering heat Max three 40 second reflows at +260°C, parts cooled to room temperature between cycles

Temperature Coefficient of Inductance (TCL) +25 to +125 ppm/°C

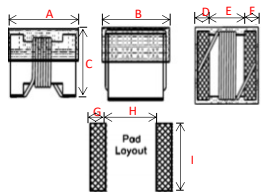
Moisture Sensitivity Level (MSL) 1 (unlimited floor life at <30°C /

85% relative humidity)

★ When ordering, please check part number

Part number	Inductance 250MHz (nH)	Inductance Tolerance	Q min	RDC (Ω) Max	IRMS (mA)	SRF (GHz) Min.
SCI2012S-2N0	2.0	B.S	45	1500	0.03	800
SCI2012S-2N2	2.2	B.S	45	1500	0.07	750
SCI2012S-2N5	2.5	B.S	45	1500	0.03	700
SCI2012S-2N8	2.8	B.S	45	1500	0.06	700
SCI2012S-3N0	3.0	B.S	30	1500	0.06	800
SCI2012S-3N3	3.3	B.S	30	1500	0.12	600
SCI2012S-3N9	3.9	B.S	70	1500	0.04	800
SCI2012S-4N7	4.7	B.J.K	70	1500	0.04	800
SCI2012S-5N6	5.6	B.J.K	55	1000	0.08	600
SCI2012S-6N8	6.8	B.J.K	50	1000	0.11	600
SCI2012S-7N5	7.5	B.J.K	50	1000	0.14	600
SCI2012S-8N2	8.2	B.J.K	50	1000	0.12	600
SCI2012S-9N1	9.1	B.J.K	65	1000	0.08	600
SCI2012S-10N	10	G.J.K	50	500	0.10	600
SCI2012S-12N	12	G.J.K	50	500	0.15	600
SCI2012S-15N	15	G.J.K	50	500	0.17	600
SCI2012S-16N	16	G.J.K	50	500	0.17	600
SCI2012S-18N	18	G.J.K	50	500	0.20	600
SCI2012S-22N	22	G.J.K	55	500	0.22	500
SCI2012S-24N	24	G.J.K	50	500	0.22	500
SCI2012S-27N	27	G.J.K	55	500	0.25	500
SCI2012S-33N	33	G.J.K	60	500	0.27	500
SCI2012S-36N	36	G.J.K	55	500	0.27	500
SCI2012S-39N	39	G.J.K	60	500	0.29	500
Part No.	Inductance 200MHz (nH)	Inductance Tolerance	Q min	RDC(Ω) Max	IRMS (mA)	SRF (GHz) Min.
SCI2012S-43N	43	G.J.K	60	500	0.34	500
SCI2012S-47N	47	G.J.K	60	500	0.31	500
SCI2012S-56N	56	G.J.K	60	500	0.34	500
SCI2012S-68N	68	G.J.K	60	500	0.38	500
Part No.	Inductance 150MHz (nH)	Inductance Tolerance	Q min	RDC(Ω) Max	IRMS (mA)	SRF (GHz) Min.
SCI2012S-82N	82	G.J.K	65	500	0.42	400
SCI2012S-91N	91	G.J.K	55	500	0.48	400
SCI2012S-R10	100	G.J.K	65	500	0.46	400
SCI2012S-R11	110	G.J.K	50	250	0.48	400
SCI2012S-R12	120	G.J.K	50	250	0.51	400
Part No.	Inductance 100MHz (nH)	Inductance Tolerance	Q min	RDC(Ω) Max	IRMS (mA)	SRF (GHz) Min.
SCI2012S-R15	150	G.J.K	50	250	0.56	400
SCI2012S-R18	180	G.J.K	50	250	0.64	400
SCI2012S-R22	220	G.J.K	50	250	1.10	400
SCI2012S-R24	240	G.J.K	44	250	1.00	350
SCI2012S-R27	270	G.J.K	48	250	1.30	350
SCI2012S-R29	290	G.J.K	48	250	1.30	330
SCI2012S-R33	330	G.J.K	48	250	1.40	310
SCI2012S-R39	390	G.J.K	48	250	1.50	290
Part No.	Inductance 50MHz (nH)	Inductance Tolerance	Q min	RDC(Ω) Max	IRMS (mA)	SRF (GHz) Min.
SCI2012S-R47	470	G.J.K	33	100	1.76	250
Part No.	Inductance 25MHz (nH)	Inductance Tolerance	Q min	RDC(Ω) Max	IRMS (mA)	SRF (GHz) Min.
SCI2012S-R56	560	G.J.K	23	50	2.50	230
SCI2012S-R62	620	G.J.K	23	50	2.20	210
SCI2012S-R68	680	G.J.K	23	50	2.05	190
SCI2012S-R75	750	G.J.K	23	50	2.25	180
SCI2012S-R82	820	G.J.K	23	50	2.35	180
SCI2012S-R91	910	G.J.K	23	50	2.45	170
SCI2012S-R100	1000	G.J.K	23	50	2.50	170
Part No.	Inductance 7.96MHz (nH)	Inductance Tolerance	Q min	RDC(Ω) Max	IRMS (mA)	SRF (GHz) Min.
SCI2012S-R120	1200	G.J.K	25	50	3.00	160
SCI2012S-R150	1500	G.J.K	25	50	3.80	150
SCI2012S-R180	1800	G.J.K	22	50	5.00	140
SCI2012S-R200	2000	G.J.K	22	50	6.00	130
SCI2012S-R220	2200	G.J.K	24	50	6.50	130
SCI2012S-R240	2400	G.J.K	23	50	6.60	120

Isolation (Vrms) : 250V. Winding to winding isolation (hipot) tested for one minute.



Dimensions	
A	2.19 MAX
B	1.73 MAX
C	1.52 MAX
D	0.55 TYP
E	1.09 TYP
F	0.55 TYP
G	1.02 TYP
H	0.76 TYP
I	1.78 TYP
unit : mm	

Impedance/Inductance/Q/ LCR Angilent E4991A

Resistance DC Chroma 16502

Current per winding that causes a 20°C rise from 25°C ambient

Electrical specifications at 25°C

Contact Us

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Japan sales-jp@bing-ri.com.tw

Official Website :

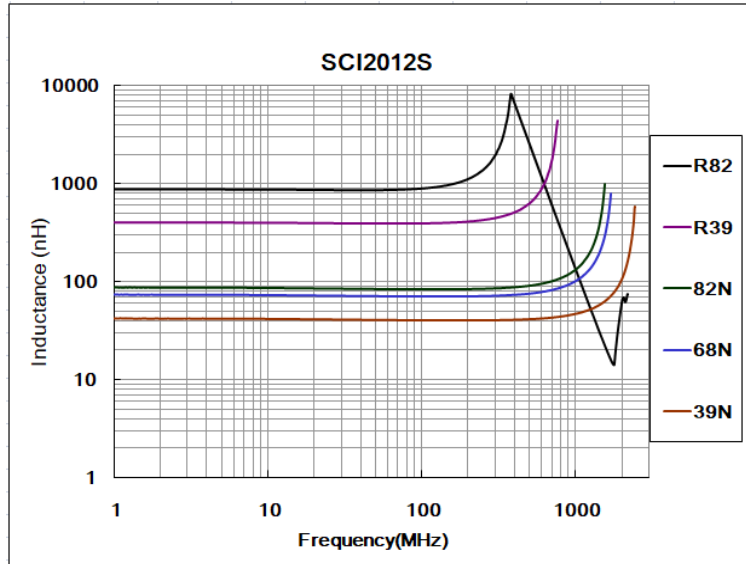
https://www.bing-ri.com.tw/

Weight 5.3 – 13.7 mg.

Packaging 2000/7 # reel; Plastic tape: 8 mm wide.

Packaging will different according the various chip size.

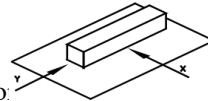
Typical Inductance vs Frequency



GENERAL CHARACTERISTICS

1. Operating temperature range: -40 TO $+125^{\circ}\text{C}$ (Includes temperature when the coil is heated)
2. External appearance: On visual inspection, the coil has no external defects.
3. Terminal strength: After soldering. Between copper plate and terminals of coil. Push in two directions of X.Y withstanding at below conditions.

Terminal should not peel off. (refer to figure at right) 0.5kg Min –2012



4. Insulating resistance: Over $100\text{M}\Omega$ at 100V D.C. between coil and core
5. Dielectric strength: No dielectric breakdown at 100V D.C. for 1 minute between coil and core
6. Temperature characteristics: Inductance coefficient $(0\sim 2,000)\times 10^{-6}/(^{\circ}\text{C } -25\sim +80)$. $^{\circ}\text{C}$, inductance deviation within $\pm 5.0\%$, after 96 hours.
7. Humidity characteristics(Moisture Resistance): Inductance deviation within $\pm 5\%$, after 96 hours in $90\sim 95\%$ relative humidity at 40 ± 2 and 1 hour drying under normal condition.
8. Vibration resistance: Inductance deviation within $\pm 5\%$, after vibration for 1 hour. In each of three orientations at sweep vibration ($10\sim 55\sim 10$ Hz) with 1.5mm P-P amplitudes.
9. Shock resistance: Inductance deviation within $\pm 5\%$, after being dropped once with 981m/s^2 (100G) shock attitude upon a rubber block method shock testing machine, in three different
10. Resistance to Soldering Heat: 260 , 10 seconds(See attached recommend reflow)
11. Storage environment: Storage condition: Temperature Range: $10 \sim 35$ (Generally: $21 \sim 31$), Humidity Range: $50\% \sim 80\%$ RH (Generally: $65\% \sim 75\%$); Transportation condition: Temperature Range: $-35 \sim 85$, Humidity Range: $50\% \sim 95\%$ RH
12. Use components within 12 months. If 12 months or more have elapsed, check solderability before use.
13. Reflow profile recommend:

Lead-free heat en duran ce test

Lead-free the recommended reflow condition

